

SPECIFICATION

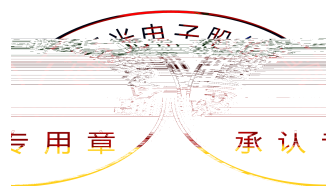
产品规格书

REFOND P/N 产品型号

RF-W2SA12WS-A47

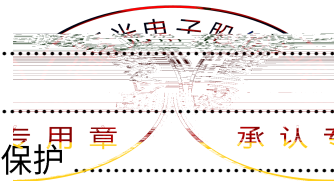
R&D 研发

Mass Product 量产供货



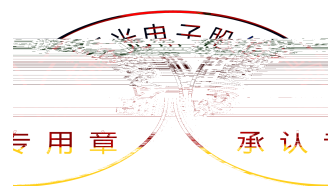
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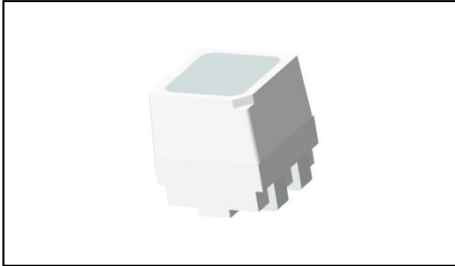
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1. Description 产品介绍

1.1 产品描述



The product is a full-color LED device, Common anode RGB SMD, The product size: 1.3mmX1.4mmX1.4mm.

该产品为全彩 LED 器件，共阳极 RGB SMD，产品尺寸 1.3mmX1.4mmX1.4mm。

1.2 Features 产品特征

Surface not reflective. 表面不反光

Extremely wide viewing angle. 发光角度大

High luminous Intensity, Low power dissipation, Good reliability and Long life.

光强度高、功耗低、可靠性好、寿命长

Water-resistant (IPX6). 防水等级(IPX6)

Moisture sensitivity level: 5a. 潮湿敏感等级:5a

RoHS compliant. 满足RoHS要求

Matte surface. 哑光表面

Pb-free reflow soldering application. 无铅回流焊

1.3 Application 产品应用

Outdoor full-color video screen. 户外全彩显示屏

Indoor and outdoor decorative lighting. 室内外装饰照明

The automobile dashboard. 汽车仪表盘

Amusement. 娱乐产品

General use. 其他应用



1.4 Package Dimension 封装尺寸

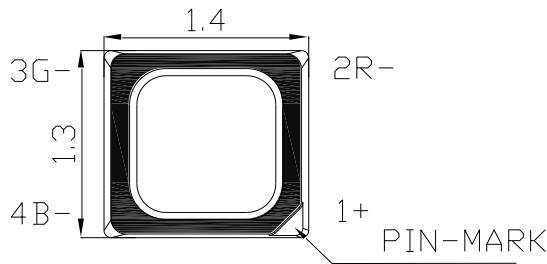


Fig.1-1 Top view 正面视图

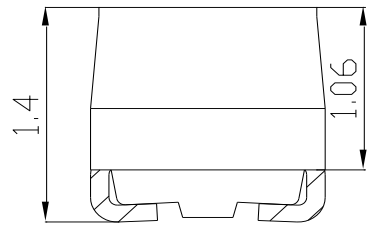


Fig.1-2 Side view 侧面视图

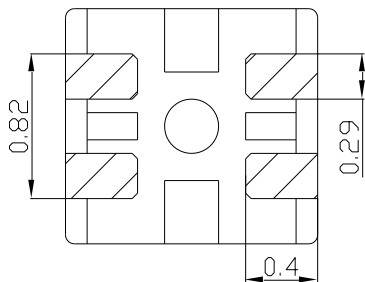


Fig.1-3 Bottom view 背面视图

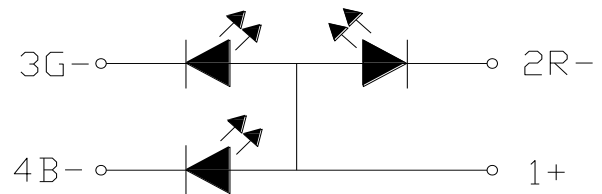


Fig.1-4 Polarity 极性

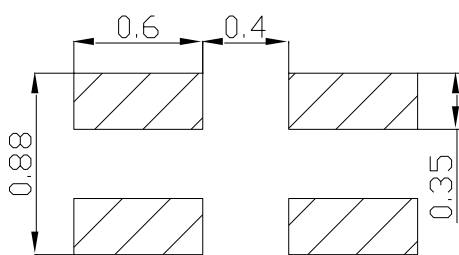
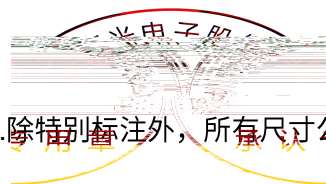


Fig.1-5 Soldering patterns 推荐焊盘

Notes 备注

1. All dimensions units are millimeters. 所有尺寸标注单位为毫米
2. All dimensions tolerances are 0.1mm unless otherwise noted. 除特别标注外, 所有尺寸公差为±0.1 毫米



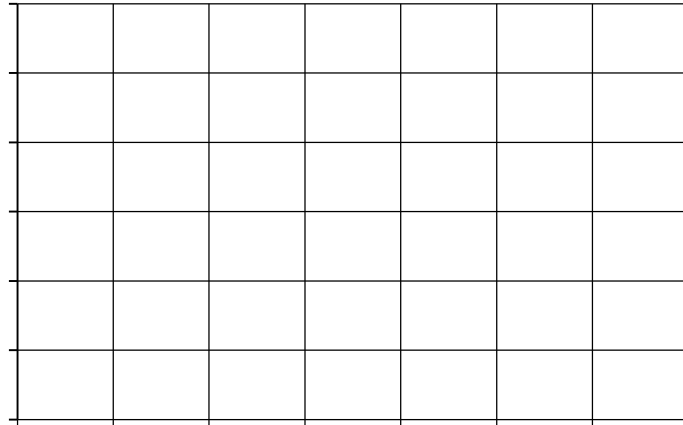


Fig 1-7 Forward Current Vs. Relative Intensity 正向电流与相对光强特性曲线

Fig 1-8 Luminous Intensity VS Ambient Temperature 光强与环境温度曲线

Fig 1-9 Solder Temperature Vs Forward Current

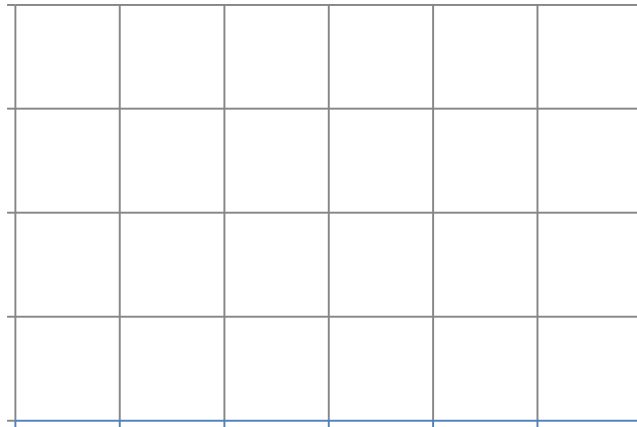
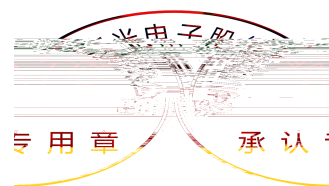


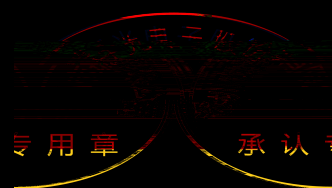
Fig 1-10 Spectrum Distribution 光谱分布特性曲线



| | | | | | |
|--|--|--|--|--|--|
| | | | | | |
| | | | | | |

Fig 1-11 Directivity X-X radiation

Fig 1-12



2. Packaging 产品包装

2.1 Packaging Specification 包装规格

Package: 11000pcs/reel. 包装每卷 11000pcs。

2.1.1 Carrier Tape Dimension 载带尺寸

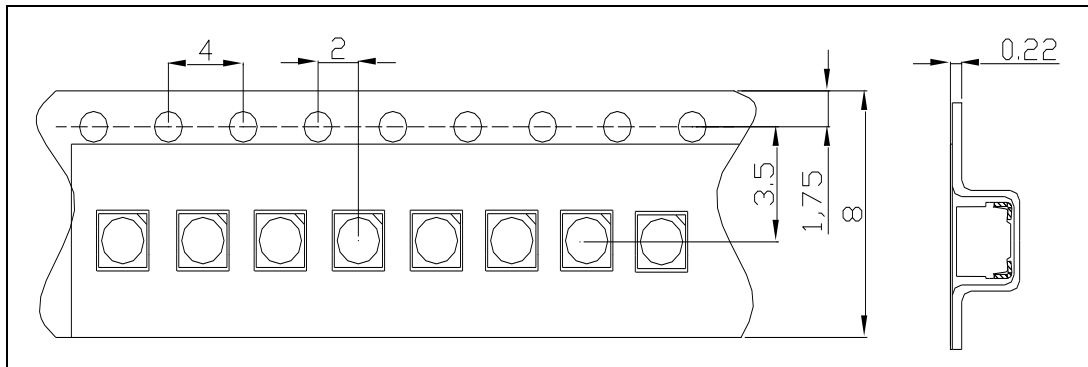


Fig.2-1 Carrier Tape Dimension 载带尺寸

2.1.2 Reel Dimension 卷盘尺寸

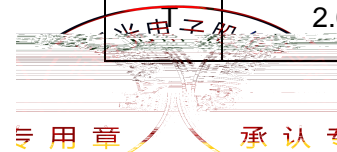
Table 2-1 Title 表名

| | |
|---|------------|
| A | 320.2±2mm |
| B | 79.5±0.2mm |
| C | 14.3±0.2mm |
| D | 2.5±0.2mm |
| E | 11.5±0.2mm |
| F | 8.7±0.3mm |
| | 2.0±0.2mm |

Fig.2-2 Title 图名

Notes 备注:

The tolerances unless mentioned ± 0.1 mm. Unit : mm 注：未注公差为 ± 0.1 毫米，尺寸单位：毫米。



2.1.3 Label Form Specification 标签规格

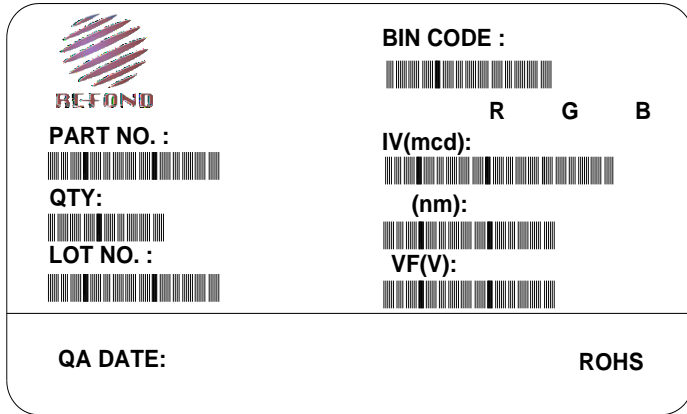


Table 2-2 Title 表名

| | | |
|----------|------------------|------|
| PART NO. | Part Number | 品名 |
| LOT NO. | Lot Number | 批次号 |
| BIN CODE | Bin Code | 参数代码 |
| IV | Light intensity | 光强 |
| VF | Forward Voltage | 正向电压 |
| D | Wavelength | 波长代码 |
| QTY | Packing Quantity | 数量 |
| DATE | Made Date | 生产日期 |

Fig 2-3 Title 图名

2.2 Moisture Resistant Packing 防潮包装

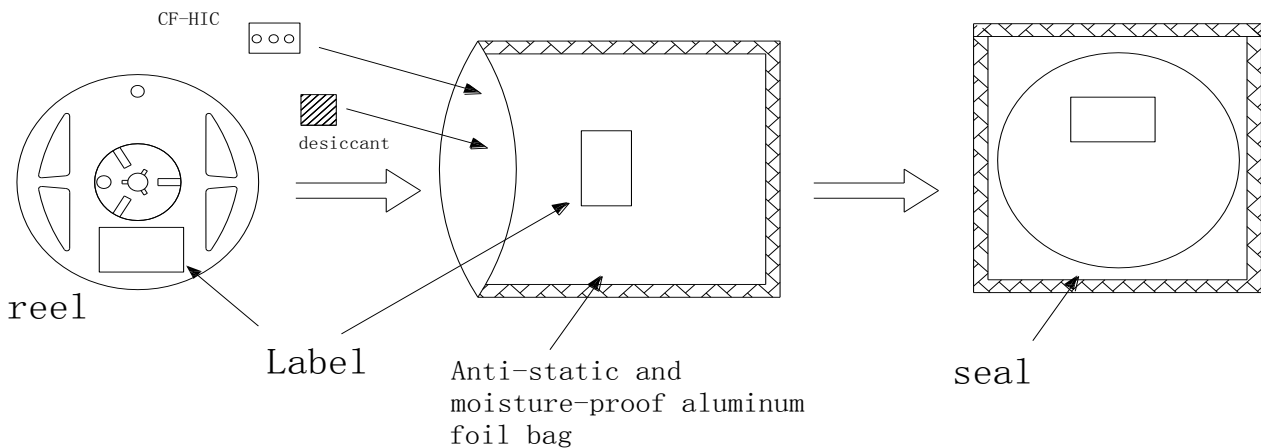
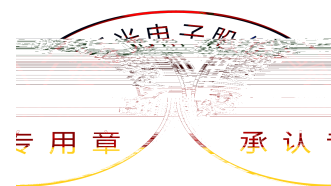


Fig.2-4 Title 图名



2.3 Cardboard Box 包装纸箱

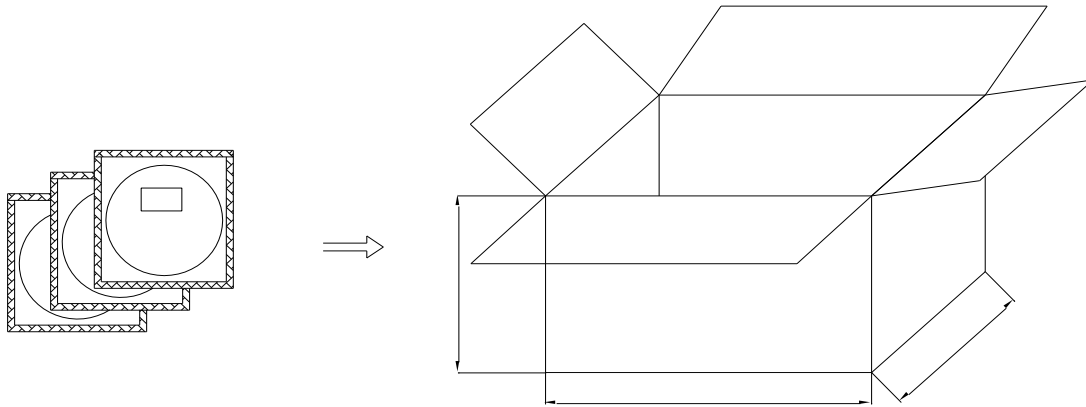


Fig.2-5 Title 图名

2.4 Reliability Test Items And Conditions 信赖性测试项目及条件

Table 2-3 Title 表名

| Test Items 项目 | Ref.Standard 参考标准 | Test Condition 测试条件 | Time 时间 | Quantity 数量 | Ac/Re 接收/拒收 |
|--------------------------------------|--------------------------|-----------------------------------|------------|----------------|----------------|
| Resistance to Soldering Heat 耐焊接热 | JESD22-B106 | Temp:260°Cmax T=10 sec | 3times | 22pcs. | 0/1 |
| Thermal Shock 冷热冲击 | JEITAED-4701 300 307 | -40°C 15min 10s 100°C 15min | 500cycle | 22pcs. | 0/1 |
| High Temperature Storage 高温保存 | JEITAED-4701 200 201 | Temp:100°C | 1000hrs. | 22pcs. | 0/1 |
| Low Temperature Storage 低温保存 | JEITA ED-4701 200 202 | Temp:-40°C | 1000hrs. | 22pcs. | 0/1 |

专用章 承认

| | | | | | |
|--|--------------------------|--|----------|--------|-----|
| Room Temperature Operating Life 常温寿命测试 | JESD22-A108 | $T_A=25^{\circ}\text{C}$ $I_F=10\text{mA}$ | 1000hrs. | 22pcs. | 0/1 |
| High Temperature High Humidity Life Test 高温高湿寿命测试 | JESD22-A101 | $85^{\circ}\text{C}/85\%R_H$ $I_F=5\text{mA}$ | 500hrs. | 22pcs. | 0/1 |
| Temperature Humidity Storage 高温高湿储存 | JEITA ED-4701 100 103 | $T_A=85^{\circ}\text{C}$ $R_H=85\%$ | 1000hrs. | 22pcs. | 0/1 |
| Low Temperature Life Test 低温寿命 | JESD22-A108D | $T_A=-40^{\circ}\text{C}$, $I_F=10\text{mA}$ | 1000hrs. | 22pcs. | 0/1 |

2.5 Criteria For Judging Damage 失效判定标准

Table 2-4 Title 表名

| Test Items 项目 | Symbol 符号 | Test Condition 测试条件 | Criteria For Judgement 判定标准 |
|--------------------------------------|--------------|------------------------|---|
| Forward Voltage 正向电压 | V_F | $I_F=20\text{mA}$ | Initial Data $\pm 10\%$ 初始值 $\pm 10\%$ |
| Reverse Current 反向电流 | I_R | $V_R = 5\text{V}$ | I_R |
| Luminous Intensity 光强 | I_V | $I_F=20\text{mA}$ | Average I_V degradation rate 平均 I_V 衰减 $\leq 30\%$ |
| Resistance to Soldering Heat 耐焊接热 | / | / | No internal cracks, no material between stripped, no dead light 材料无内部裂痕、剥离、无死灯 |

Table 3-1 Title 表名

| | |
|--|----------------------|
| Average temperature rise speed平均升温速度 (T _{max} 至T _P) | Max 4 °C/ s 最高4 °C/秒 |
| Preheating: minimum temperature预热：最低温度 (T _{min}) | 150 °C |
| Preheating: Max temperature预热：最高温度 (T _{max}) | 200 °C |
| Preheating: Time预热：时间 (T _{min} 至T _{max}) | 60s-120s 60 - 120) |

4.Handling Precautions 产品使用注意事项

4.1 Handling Precautions 产品使用注意事项

4.1.1 Storage 贮存

(1) Moisture proof and anti-electrostatic package with moisture absorbent material is used, Packaged products have one year to save time.

本产品使用密封防潮抗静电袋包装,并附有干燥剂,未开封的产品保存时间一年。

(2) Before opening the package, the product should be kept at 30°C or less and humidity less than 60%RH.

开封前,产品须存放在温度不高于30°C,湿度不高于60%RH的环境中。

(3) Seal anti-electrostatic bag humidity card should immediately check bag humidity indicator card in the open the bag after, Humidity is greater than or equal to 30%, Must be baked before use
密封防静电袋内的湿度卡应在打开袋子后立即查看袋内的湿度指示卡来确定,湿度显示大于或等于30%时,使用前须进行烘烤。

(4) After opening the package, the product should be soldered within 24 hours. If not, please store at 30°C or less and humidity less than 10%RH. It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.

开封后,产品必须24小时内使用完(建议工作环境温度不高于30°C,湿度不高于60%),如未使用完,余料须存放在温度不高于30°C,湿度不高于10%的环境中。

(5) If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition : 65±5°C for 24 hours.

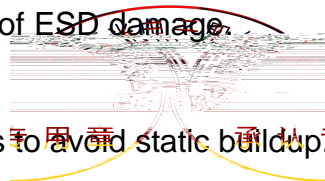
对于尚未焊接的LED,如果吸湿剂或包装失效,或者产品没有符合以上有效存储条件,烘烤可以起到一定的性能恢复效果,烘烤条件:65±5°C,持续时间24H。

4.1.2 Static Electricity 静电

(1) The following procedures may decrease the possibility of ESD damage.

以下操作可降低静电破坏的可能性

(2) Minimize friction between the product and surroundings to avoid static buildup.



将产品和外界之间的摩擦减到最低以避免静电产生

(3) All production machinery and test instruments must be electrically grounded.

所有的产品设备和测试仪器必须接地。

(4) Operators must wear anti-static bracelets.

操作人员必须配戴静电环。

(5) Wear anti-static suit when entering work areas with conductive machinery.

进入带电设备工作区域时需穿防静电服。

(6) All workstations that handle IC and ESD-sensitive components must maintain an electrostatic potential of 150V or less.

所有操作 IC 和 ESD 敏感器件元器件的工作台必须保持低于

4.1.5 Others 其它事项

Do not directly touch or handle the epoxy surface. It may damage the internal circuitry.

Handle the component along the side surfaces by using forceps or appropriate tools.

请勿直接触摸或操作环氧树脂表面，这可能会损坏内部的电路，~~拿取时用镊子或合适的工具夹在元件的侧边~~

4.1.6 Declare 申明

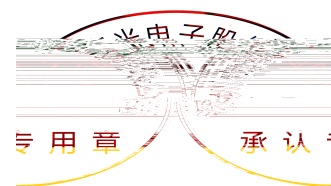
(1) This specification is written both in English and in Chinese and the latter is formal.

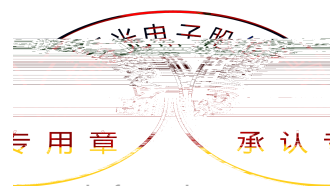
~~此规格书同时以中英文书写，且中文为正式规格书。~~

(2) Both the customers and Refond will agree on official specifications of supplied products before

reserves the right to further modify the specification for technical reference and sample without noticing the customers.

在量产供货前，瑞丰需与客户签署一式两份的规格书，一份由瑞丰保留，一份由客户保留。瑞丰保留作为技术参考以及送样时提供的规格书，瑞丰保留进一步修改而不需通知客户的权力。





Declare 申明

This specification is written both in English and in Chinese and the latter is formal.

产品规格书以中英文方式书写，若有冲突以中文版本为准。